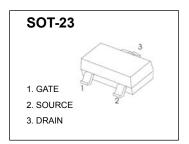


## **SOT-23 Plastic-Encapsulate MOSFETS**

### UMW IRLML2502 N-Channel 20-V(D-S) MOSFET

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> MAX	I <sub>D</sub>
20 V	45mΩ@4.5V	•
	80 mΩ@2.5V	4.2A



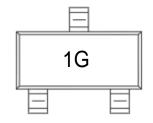
#### **FEATURE**

TrenchFET Power MOSFET

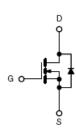
#### **APPLICATION**

- Load Switch for Portable Devices
- DC/DC Converter

#### **MARKING**



#### **Equivalent Circuit**



#### Maximum ratings (T<sub>a</sub>=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit	
Drain-Source Voltage	V <sub>DS</sub>	20	V	
Gate-Source Voltage	V <sub>GS</sub>	±12	V	
Continuous Drain Current	I <sub>D</sub>	4.2	^	
Continuous Source-Drain Current(Diode Conduction)	Is	0.6	A	
Power Dissipation	P <sub>D</sub>	1.25	W	
Thermal Resistance from Junction to Ambient (t≤5s)	$R_{\theta JA}$	312.5	°C/W	
Operating Junction	TJ	150	°C	
Storage Temperature	T <sub>STG</sub>	-55 ~+150	°C	



## SOT-23 Plastic-Encapsulate MOSFETS

T<sub>a</sub>=25 °C unless otherwise specified

Parameter	Symbol	Test Condition	Min	Тур	Max	Units	
Static			•				
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>G</sub> S = 0V, I <sub>D</sub> =10µA	20			V	
Gate-threshold voltage	V <sub>GS</sub> (th)	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =50μA	0.65		1.2		
Gate-body leakage	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±8V	V <sub>DS</sub> =0V, V <sub>GS</sub> =±8V		±100	nA	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V			1	μA	
Drain-source on-resistance <sup>a</sup>		V <sub>GS</sub> =4.5V, I <sub>D</sub> =4.2A		0.035	0.045		
	fDS(on)	V <sub>GS</sub> =2.5V, I <sub>D</sub> =3.6A		0.050	0.080	Ω	
Forward transconductance <sup>a</sup>	<b>G</b> fs	V <sub>DS</sub> =5V, I <sub>D</sub> =3.6A		8		S	
Diode forward voltage	V <sub>SD</sub>	I <sub>S</sub> =0.94A,V <sub>GS</sub> =0V		0.76	1.2	V	
Dynamic							
Total gate charge	Qg			4.0	10	nC	
Gate-source charge	$Q_{gs}$	V <sub>DS</sub> =10V,V <sub>GS</sub> =4.5V,I <sub>D</sub> =3.6A		0.65			
Gate-drain charge	$Q_{gd}$			1.5			
Input capacitance b	C <sub>iss</sub>			300		pF	
Output capacitance <sup>b</sup>	C <sub>oss</sub>	V <sub>DS</sub> =10V,V <sub>GS</sub> =0V,f=1MHz		120			
Reverse transfer capacitance <sup>b</sup>	C <sub>rss</sub>			80			
Switching <sup>b</sup>	<b>'</b>	1	•	JI.	l.		
Turn-on delay time	t <sub>d(on)</sub>			7	15		
Rise time	tr	V <sub>DD</sub> =10V,		55	80	- ns	
Turn-off delay time	td(off)	R <sub>L</sub> =5.5Ω, I <sub>D</sub> ≈3.6A,		16	60		
Fall time	tf	$V_{GEN}$ =4.5V,Rg=6 $\Omega$		10	25		

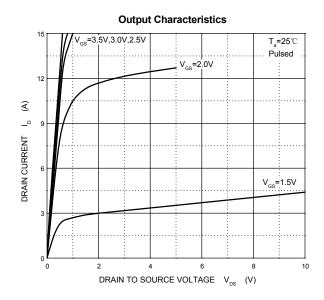
#### Notes:

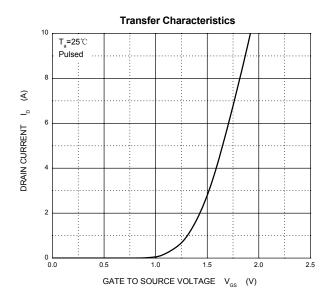
a. Pulse Test : Pulse width≤300µs, duty cycle ≤2%.

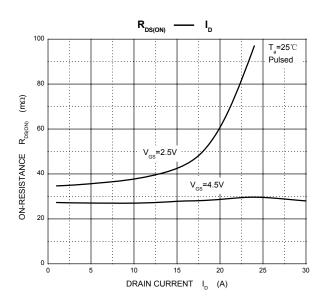
b. These parameters have no way to verify.

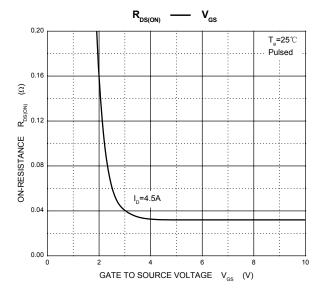


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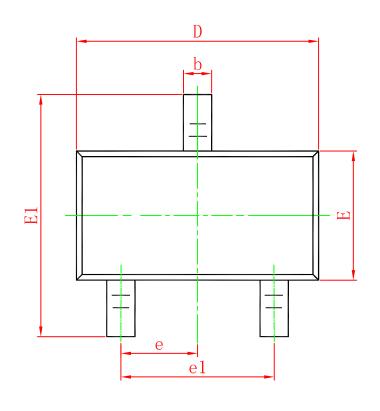


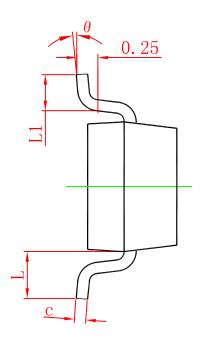


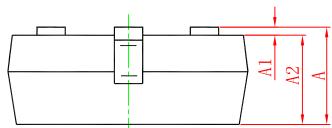




# SOT-23 Plastic-Encapsulate MOSFETS SOT-23 PACKAGE OUTLINE DIMENSIONS







Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP.		0.037 TYP.		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF.		0.022 REF.		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	